TLV8811,TLV8812 425 nA Precision Nanopower Op Amps for Cost-Optimized Systems

1 Features

· For Cost-Optimized Systems

Nanopower Supply Current: 425 nA/channel

Offset Voltage: 500 µV (max)

TcVos: 1 µV/°C

• Gain-Bandwidth: 6 kHz

· Unity-Gain Stable

Low Input Bias Current: 100 fA
Wide Supply Range: 1.7 V to 5.5 V

· Rail-to-Rail Output

No Output Reversals

EMI Protection

Temperature Range: –40°C to 125°C

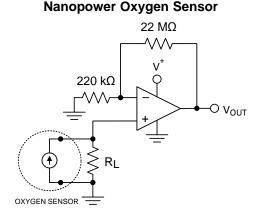
Industry Standard Packages:

Single in 5-pin SOT-23

Dual in 8-pin VSSOP

2 Applications

- Gas Detectors (CO and O₂)
- PIR Motion Detectors
- Current Sensing
- Thermostats
- IoT (Internet of Things) Remote Sensors
- Active RFID Readers and Tags
- Portable Medical Equipment
- Portable Glucose Monitors



3 Description

The TLV8811 (single) and TLV8812 (dual) family of precision ultra-low-power operational amplifiers are ideal for cost-optimized, "Always ON" sensing applications in battery powered wireless and low power wired equipment. With 6 kHz of bandwidth from 425 nA of guiescent current and a trimmed offset voltage to under 500µV, the TLV881x amplifiers provide high precision while minimizing power consumption in equipment such as CO gas detectors and portable electronic devices where operational battery-life is critical. They also have a carefully designed CMOS input stage enabling very low, fempto-amp bias currents, thereby reducing IBIAS and IOS errors that would otherwise impact sensitive applications like transimpedance amplifier (TIA) configurations with megaohm feedback resistors, and high source impedance sensing applications. The TLV881x amplifiers also feature a negative-rail sensing input stage and a rail-to-rail output stage that swings within millivolts of the rails, maintaining the widest dynamic range possible. Additionally, built-in EMI protection reduces sensitivity to unwanted RF signals from mobile phones, WiFi, radio transmitters, and tag readers.

The TLV8811 (single) and TLV8812 (dual) channel versions are available in industry standard 5-pin SOT-23 and 8-pin VSSOP packages respectively.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE				
TLV8811	SOT-23 (5)	2.90 mm x 1.60 mm				
TLV8812	VSSOP (8)	3.00 mm × 3.00 mm				

 For all available packages, see the orderable addendum at the end of the data sheet.

Nanopower CO Sensor

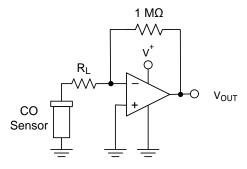


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4 Revision History

DATE	REVISION	NOTES
October 2016	*	Initial release.

5 Device Comparison

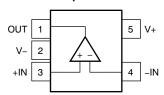
LPV8xx and TLV88xx Family of Nanopower Amplifiers

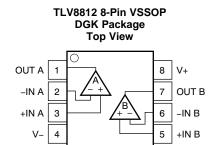
PART NUMBER	CHANNELS	SUPPLY CURRENT (Typ per Channel)	OFFSET VOLTAGE (Max at 25°C)						
LPV801	1	500 nA	3.5 mV						
LPV802	2	320 nA	3.5 mV						
LPV811	1	450 nA	370 μV						
LPV812	2	425 nA	300 μV						
TLV8801	1	500 nA	4.5 mV						
TLV8802	2	320 nA	4.5 mV						
TLV8811	1	450 nA	550 μV						
TLV8812	2	425 nA	500 μV						

TLV88xx devices are for cost optimized systems

6 Pin Configuration and Functions

TLV8811 5-Pin SOT-23 DBV Package Top View





Pin Functions: TLV8811 DBV

PIN		TYPE	DESCRIPTION				
NAME	NUMBER	TTPE	DESCRIPTION				
OUT	1	0	Output				
-IN	4	I	nverting Input				
+IN	3	I	Non-Inverting Input				
V-	2	Р	Negative (lowest) power supply				
V+	5	Р	Positive (highest) power supply				

Pin Functions: TLV8812 DGK

PIN		TVDE	DESCRIPTION			
NAME	NUMBER	TYPE	DESCRIPTION			
OUT A	1	0	Channel A Output			
-IN A	2	1	Channel A Inverting Input			
+IN A	3	1	Channel A Non-Inverting Input			
V-	4	Р	Negative (lowest) power supply			
+IN B	5	I	Channel B Non-Inverting Input			
-IN B	6	I	Channel B Inverting Input			
OUT B	7	0	Channel B Output			
V+	8	Р	Positive (highest) power supply			

7 Specifications

7.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) (1)

			MIN	MAX	UNIT
Supply voltage,	$V_S = (V+) - (V-)$	-0.3	6	V	
lanut nina	Voltage (2) (3)	Common mode	(V-) - 0.3	(V+) + 0.3	V
Input pins		Differential	(V-) - 0.3	(V+) + 0.3	V
Input pins Current				10	mA
Output short current (4)		Continuous	Continuous		
Storage tempera	ature, T _{stg}	-65	150	°C	
Junction temper	ature		150	°C	

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Not to exceed -0.3V or +6.0V on ANY pin, referred to V-
- (3) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.3 V beyond the supply rails should be current-limited to 10 mA or less.
- (4) Short-circuit to Vs/2, one amplifier per package. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C.

7.2 ESD Ratings

			VALUE	UNIT	l
		Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)	±1000		ĺ
V _(ESD) E	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	±250	V	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 500-V HBM is possible with the necessary precautions. Pins listed as ±2000 V may actually have higher performance.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 250-V CDM is possible with the necessary precautions. Pins listed as ±750 V may actually have higher performance.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

g (masses and masses)	MIN	MAX	UNIT
Supply voltage (V+ – V–)	1.7	5.5	V
Specified temperature	-40	125	°C

7.4 Thermal Information

	THERMAL METRIC ⁽¹⁾	TLV8811 DBV (SOT-23) 5 PINS	TLV8812 DGK (VSSOP) 8 PINS	UNIT
θ_{JA}	Junction-to-ambient thermal resistance	177.4	177.6	
θ_{JCtop}	Junction-to-case (top) thermal resistance	133.9	68.8	
θ_{JB}	Junction-to-board thermal resistance	36.3	98.2	°C/W
ΨЈТ	Junction-to-top characterization parameter	23.6	12.3	
ΨЈВ	Junction-to-board characterization parameter	35.7	96.7	

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

7.5 Electrical Characteristics

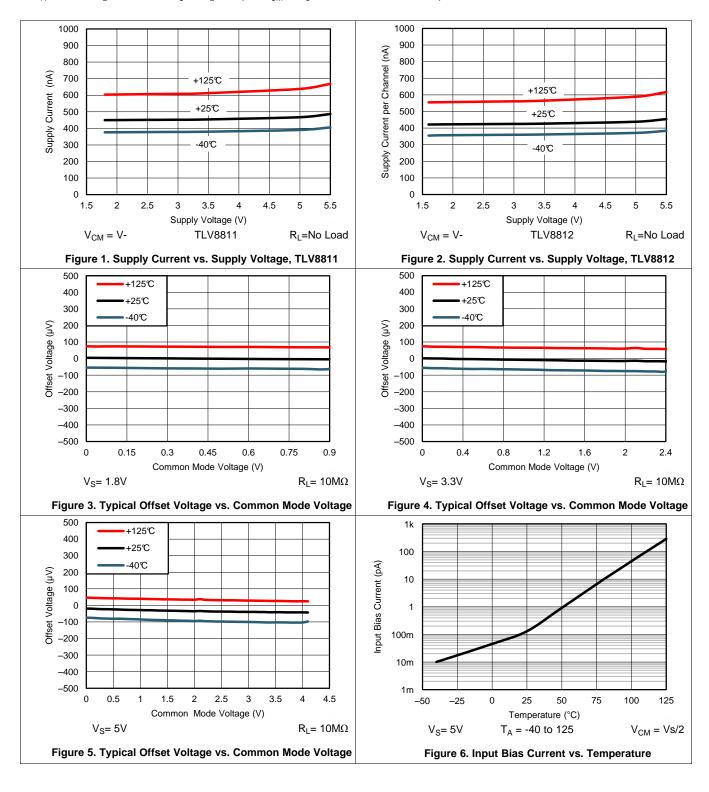
 $\underline{T_{\text{A}}} = 25^{\circ}\text{C}, \ V_{\text{S}} = 1.8 \ \text{V to 5 V}, \ V_{\text{CM}} = V_{\text{OUT}} = V_{\text{S}}/2, \ \text{and} \ R_{\text{L}} \\ \geq 10 \ \text{M}\Omega \ \text{to} \ V_{\text{S}} \ / \ 2, \ \text{unless otherwise noted}^{(1)} \ . \\$

	PARAMETER	TEST CONDIT	ONS	MIN	TYP	MAX	UNIT
OFFSET	VOLTAGE						
V	Input offset voltage, TLV8811	V_S = 1.8V and 3.3V, V_{CM} = V-			±75 ⁽¹⁾	±550 ⁽¹⁾	μV
V _{os}	Input offset voltage, TLV8812	V_S = 1.8V and 3.3V, V_{CM} = V-			±55	±500	μV
$\Delta V_{OS}/\Delta T$	Input offset drift	V _{CM} = V-	$T_A = -40^{\circ}C \text{ to } 125^{\circ}C$		±1		μV/°C
PSRR	Power-supply rejection ratio	$V_S = 1.8V \text{ to } 3.3V, \ V_{CM} = V$			±1.6	±60	μV/V
INPUT VO	OLTAGE RANGE						
V _{CM}	Common-mode voltage range	V _S = 3.3V		0		2.4	V
CMRR	Common-mode rejection ratio	$(V-) \le V_{CM} \le (V+) - 0.9 \text{ V}, V_S = 3$.3V	80	98		dB
INPUT BI	AS CURRENT						
I_B	Input bias current	V _S = 1.8V			±100		fA
Ios	Input offset current	V _S = 1.8V			±100		fA
INPUT IM	PEDANCE						
	Differential				7		pF
	Common mode				3		pF
NOISE							
E _n	Input voltage noise	f = 0.1 Hz to 10 Hz			8		μVp-p
e_{n}	Input voltage noise	f = 100 Hz		360		nV/√ Hz	
	density	f = 1 kHz			450		110/ 1112
OPEN-LO	OP GAIN						
A_{OL}	Open-loop voltage gain	$(V-) + 0.3 V \le V_O \le (V+) - 0.3 V$,	$R_L = 100 \text{ k}\Omega$		120		dB
OUTPUT							
V _{OH}	Voltage output swing from positive rail	$V_S = 1.8V$, $R_L = 100 \text{ k}\Omega$ to $V^+/2$		10	3.5		mV
V _{OL}	Voltage output swing from negative rail	$V_S = 1.8V$, $R_L = 100 \text{ k}\Omega$ to $V^+/2$			2.5	10	IIIV
I _{SC}	Short-circuit current	$V_S = 3.3V$, Short to $V_S/2$			4.7		mA
Z _O	Open loop output impedance	f = 1 KHz, I _O = 0 A			90		kΩ
FREQUE	NCY RESPONSE						
GBP	Gain-bandwidth product	$C_L = 20 \text{ pF}, R_L = 10 \text{ M}\Omega, V_S = 5 \text{V}$			6		kHz
SR	Slew rate (10% to 90%)	$G = 1$, Rising Edge, $C_L = 20 pF$, V		1.4		V/ms	
Sicw rate (10/6 to 90%)		G = 1, Falling Edge, C _L = 20 pF, V		1.5		V/1115	
POWER SUPPLY							
	Quiescent Current, TLV8811 ⁽¹⁾	$V_{CM} = V_{-}, I_{O} = 0, V_{S} = 3.3V$			450	750	nA
IQ	Quiescent Current, Per Channel, TLV8812	$V_{CM} = V_{-}, I_{O} = 0, V_{S} = 3.3V$			425		00

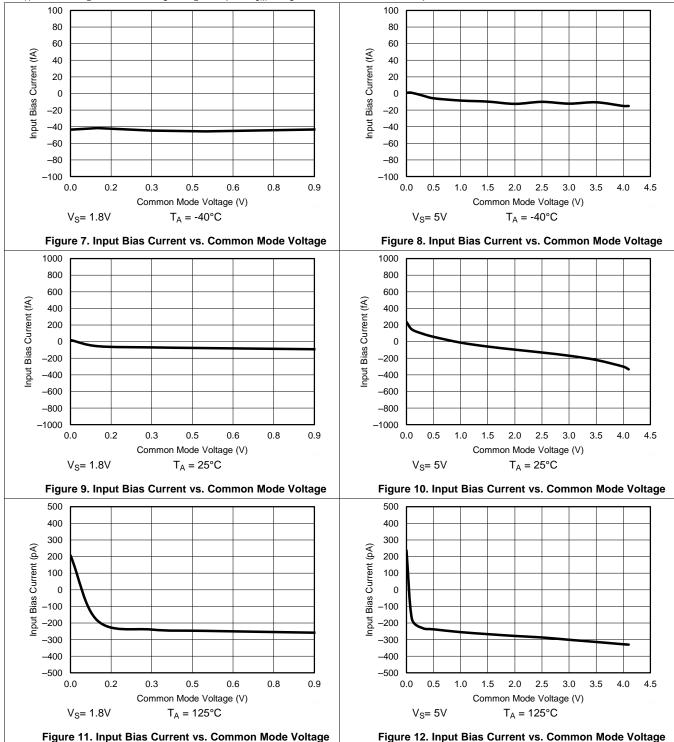
⁽¹⁾ Limits for the TLV8811 are preliminary until release and are subject to change

7.6 Typical Characteristics

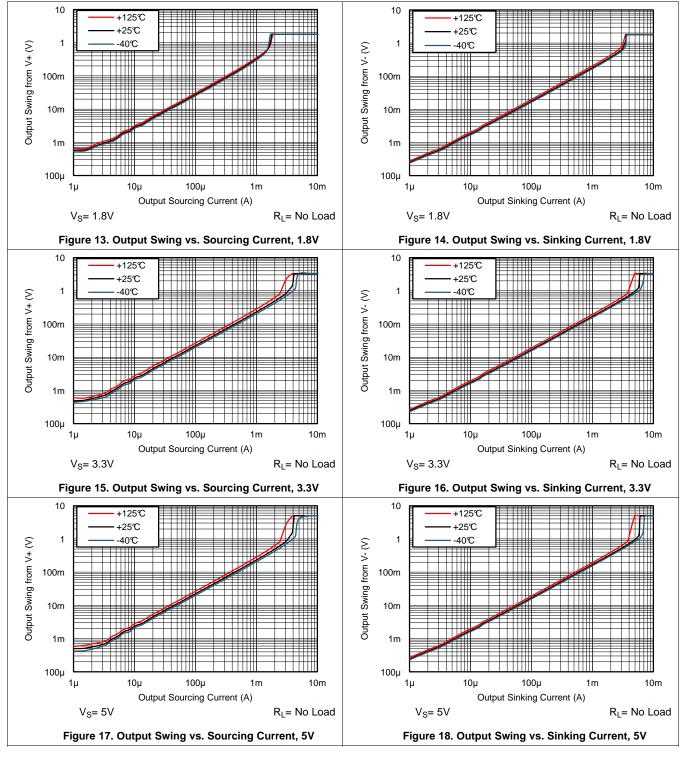
at T_A = 25°C, R_L = 10M Ω to $V_S/2$, C_L = 20pF, V_{CM} = V_S / 2V unless otherwise specified.



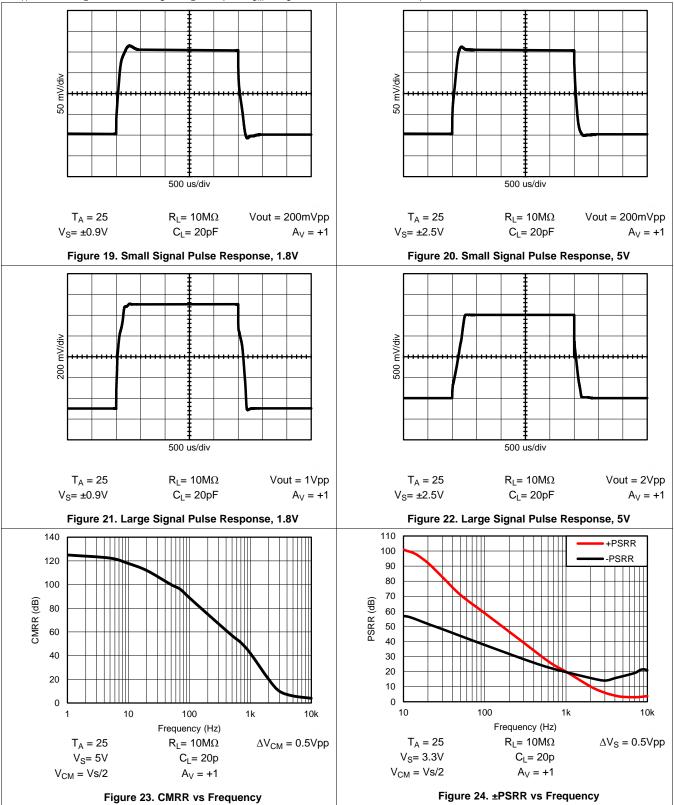
at T_A = 25°C, R_L = 10M Ω to $V_S/2$, C_L = 20pF, V_{CM} = V_S / 2V unless otherwise specified.



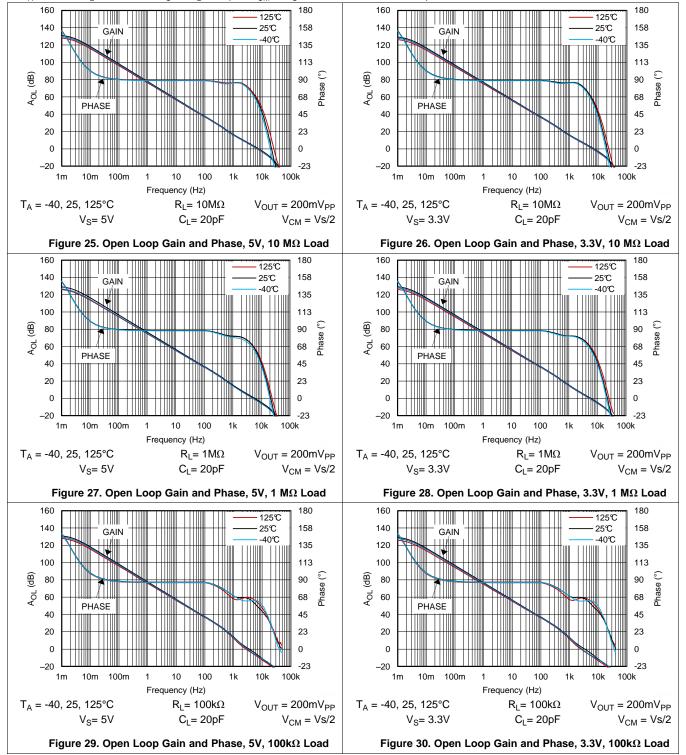




at T_A = 25°C, R_L = 10M Ω to $V_S/2$, C_L = 20pF, V_{CM} = V_S / 2V unless otherwise specified.









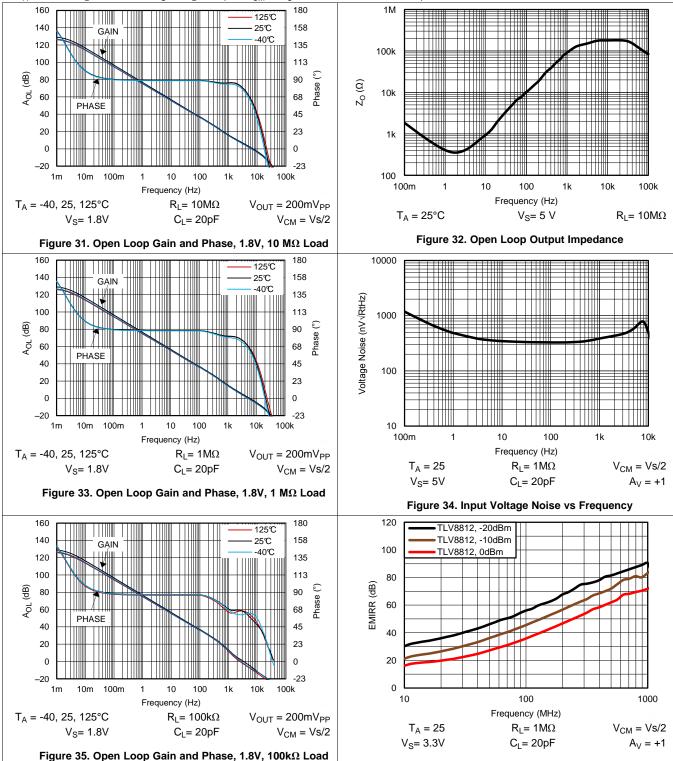


Figure 36. EMIRR Performance

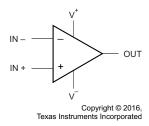
8 Detailed Description

8.1 Overview

The TLV8811 (single) and TLV8812 (dual) series of nanoPower CMOS operational amplifiers are designed for long-life battery-powered and energy harvested applications. They operate on a single supply with operation as low as 1.7V. The Input Offset is trimmed to less than 500uV and the output is rail-to-rail and swings to within 3.5mV of the supplies with a $100k\Omega$ load. The common-mode range extends to the negative supply making it ideal for single-supply applications. EMI protection has been employed internally to reduce the effects of EMI.

Parameters that vary significantly with operating voltages or temperature are shown in the *Typical Characteristics* curves.

8.2 Functional Block Diagram



8.3 Feature Description

The amplifier's differential inputs consist of a non-inverting input (+IN) and an inverting input (-IN). The amplifier amplifies only the difference in voltage between the two inputs, which is called the differential input voltage. The output voltage of the op-amp V_{OUT} is given by Equation 1:

$$V_{OUT} = A_{OL} (IN^+ - IN^-)$$

where

A_{OL} is the open-loop gain of the amplifier, typically around 120 dB (1,000,000x, or 1,000,000 Volts per microvolt).

8.4 Device Functional Modes

8.4.1 Negative-Rail Sensing Input

The input common-mode voltage range of the TLV881x extends from (V-) to (V+)-0.9 V. In this range, low offset can be expected with a minimum of 80dB CMRR. The TLV881x is protected from output "inversions" or "reversals".

8.4.2 Rail to Rail Output Stage

The TLV881x output voltage swings 3.5 mV from rails at 1.8 V supply, which provides the maximum possible dynamic range at the output. This is particularly important when operating on low supply voltages.

The TLV881x Maximum Output Voltage Swing graph defines the maximum swing possible under a particular output load.

8.4.3 Design Optimization for Nanopower Operation

When designing for ultralow power, choose system feedback components carefully. To minimize quiescent current consumption, select large-value feedback resistors. Any large resistors will react with stray capacitance in the circuit and the input capacitance of the operational amplifier. These parasitic RC combinations can affect the stability of the overall system. A feedback capacitor may be required to assure stability and limit overshoot or gain peaking.

When possible, use AC coupling and AC feedback to reduce static current draw through the feedback elements. Use film or ceramic capacitors since large electrolytics may have large static leakage currents in the nanoamps.

Device Functional Modes (continued)

8.4.4 Driving Capacitive Load

The TLV881x is internally compensated for stable unity gain operation, with a 6 kHz typical gain bandwidth. However, the unity gain follower is the most sensitive configuration to capacitive load. The combination of a capacitive load placed directly on the output of an amplifier along with the amplifier's output impedance creates a phase lag, which reduces the phase margin of the amplifier. If the phase margin is significantly reduced, the response will be under damped which causes peaking in the transfer and, when there is too much peaking, the op amp might start oscillating.

In order to drive heavy (>50pF) capacitive loads, an isolation resistor, $R_{\rm ISO}$, should be used, as shown in Figure 37. By using this isolation resistor, the capacitive load is isolated from the amplifier's output. The larger the value of $R_{\rm ISO}$, the more stable the amplifier will be. If the value of $R_{\rm ISO}$ is sufficiently large, the feedback loop will be stable, independent of the value of $C_{\rm L}$. However, larger values of $R_{\rm ISO}$ result in reduced output swing and reduced output current drive. The recommended value for $R_{\rm ISO}$ is 30-50k Ω .

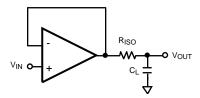


Figure 37. Resistive Isolation Of Capacitive Load

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The TLV881x is a ultra-low power operational amplifier that provides 6 kHz bandwidth with only 450nA typical quiescent current, trimmed input offset voltage and precision drift specifications. These rail-to-rail output amplifiers are specifically designed for battery-powered applications. The input common-mode voltage range extends to the negative supply rail and the output swings to within millivolts of the rails, maintaining a wide dynamic range.

9.2 Typical Application: Three Terminal CO Gas Sensor Amplifier

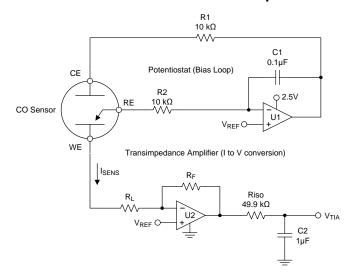


Figure 38. Three Terminal Gas Sensor Amplifier Schematic

9.2.1 Design Requirements

Figure 38 shows a simple micropower potentiostat circuit for use with three terminal unbiased CO sensors, though it is applicable to many other type of three terminal gas sensors or electrochemical cells.

The basic sensor has three electrodes; The Sense or Working Electrode ("WE"), Counter Electrode ("CE") and Reference Electrode ("RE"). A current flows between the CE and WE proportional to the detected concentration.

The RE monitors the potential of the internal reference point. For an unbiased sensor, the WE and RE electrodes must be maintained at the same potential by adjusting the bias on CE. Through the Potentiostat circuit formed by U1, the servo feedback action will maintain the RE pin at a potential set by V_{REF} .

R1 is to maintain stability due to the large capacitance of the sensor. C1 and R2 form the Potentiostat integrator and set the feedback time constant.

U2 forms a transimpedance amplifier ("TIA") to convert the resulting sensor current into a proportional voltage. The transimpedance gain, and resulting sensitivity, is set by R_F according to Equation 2.

$$V_{TIA} = (-I * R_F) + V_{REF} \tag{2}$$

 R_L is a load resistor of which the value is normally specified by the sensor manufacturer (typically 10 ohms). The potential at WE is set by the applied $V_{REF.}$ Riso provides capacitive isolation and, combined with C2, form the output filter and ADC reservoir capacitor to drive the ADC.

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Typical Application: Three Terminal CO Gas Sensor Amplifier (continued)

9.2.2 Detailed Design Procedure

For this example, we will be using a CO sensor with a sensitivity of 69nA/ppm. The supply voltage and maximum ADC input voltage is 2.5V, and the maximum concentration is 300ppm.

First the V_{REF} voltage must be determined. This voltage is a compromise between maximum headroom and resolution, as well as allowance for "footroom" for the minimum swing on the CE terminal, since the CE terminal generally goes negative in relation to the RE potential as the concentration (sensor current) increases. Bench measurements found the difference between CE and RE to be 180mV at 300ppm for this particular sensor.

To allow for negative CE swing "footroom" and voltage drop across the 10k resistor, 300mV was chosen for V_{REF} .

Therefore +300mV will be used as the minimum V_{ZERO} to add some headroom.

 $V_{ZERO} = V_{REF} = +300 \text{mV}$

where

- V_{ZERO} is the zero concentration voltage
- V_{REF} is the reference voltage (300mV)

(3)

Next we calculate the maximum sensor current at highest expected concentration:

 $I_{SENSMAX} = I_{PERPPM} * ppmMAX = 69nA * 300ppm = 20.7uA$

where

- I_{SENSMAX} is the maximum expected sensor current
- I_{PERPPM} is the manufacturer specified sensor current in Amps per ppm
- ppmMAX is the maximum required ppm reading

(4)

Now find the available output swing range above the reference voltage available for the measurement:

$$V_{SWING} = V_{OUTMAX} - V_{ZERO} = 2.5V - 0.3V = 2.2V$$

where

- V_{SWING} is the expected change in output voltage
- V_{OUTMAX} is the maximum amplifier output swing (usually near V+)

(5)

Now we calculate the transimpedance resistor $@_F$) value using the maximum swing and the maximum sensor current:

$$R_F = V_{SWING} / I_{SENSMAX} = 2.2V / 20.7\mu A = 106.28 k\Omega$$
 (we will use 110 k Ω for a common value) (6)

Typical Application: Three Terminal CO Gas Sensor Amplifier (continued)

9.2.3 Application Curve

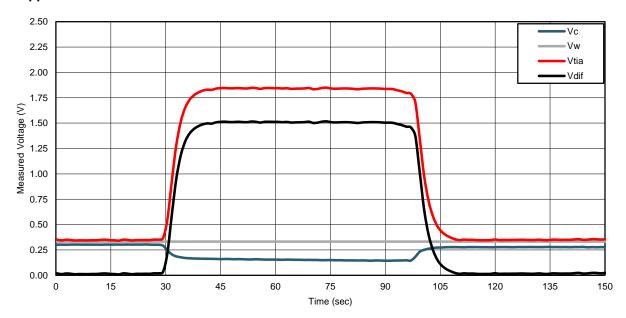


Figure 39. Monitored Voltages when exposed to 200ppm CO

Figure 39 shows the resulting circuit voltages when the sensor was exposed to 200ppm step of carbon monoxide gas. V_C is the monitored CE pin voltage and clearly shows the expected CE voltage dropping below the WE voltage, V_W , as the concentration increases.

 V_{TIA} is the output of the transimpedance amplifier U2. V_{DIFF} is the calculated difference between V_{REF} and V_{TIA} , which will be used for the ppm calculation.

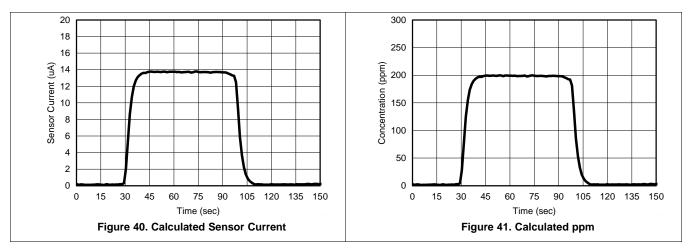


Figure 40 shows the calculated sensor current using the formula in Equation 7:

$$I_{SENSOR} = V_{DIFF} / R_F = 1.52 \text{V} / 110 \text{ k}\Omega = 13.8 \text{uA}$$
 (7)

Equation 8 shows the resulting conversion of the sensor current into ppm.

$$ppm = I_{SENSOR} / I_{PERPPM} = 13.8 \mu A / 69 nA = 200$$
 (8)

Total supply current for the amplifier section is less than 700 nA, minus sensor current. Note that the sensor current is sourced from the amplifier output, which in turn comes from the amplifier supply voltage. Therefore, any continuous sensor current must also be included in supply current budget calculations.

9.3 Do's and Don'ts

Do properly bypass the power supplies.

Do add series resistance to the output when driving capacitive loads, particularly cables, Muxes and ADC inputs.

Do add series current limiting resistors and external schottky clamp diodes if input voltage is expected to exceed the supplies. Limit the current to 1mA or less (1K Ω per volt).

10 Power Supply Recommendations

The TLV881x is specified for operation from 1.7 V to 5.5 V (±0.85 V to ±2.75 V) over a -40°C to 125°C temperature range. Parameters that can exhibit significant variance with regard to operating voltage or temperature are presented in the *Typical Characteristics*.

CAUTION

Supply voltages larger than 6 V can permanently damage the device.

For proper operation, the power supplies must be properly decoupled. For decoupling the supply lines it is suggested that 100 nF capacitors be placed as close as possible to the operational amplifier power supply pins. For single supply, place a capacitor between V⁺ and V⁻ supply leads. For dual supplies, place one capacitor between V⁺ and ground, and one capacitor between V⁻ and ground.

Low bandwidth nanopower devices do not have good high frequency (> 1 kHz) AC PSRR rejection against high-frequency switching supplies and other 1 kHz and above noise sources, so extra supply filtering is recommended if kilohertz or above noise is expected on the power supply lines.

11 Layout

11.1 Layout Guidelines

The V+ pin should be bypassed to ground with a low ESR capacitor.

The optimum placement is closest to the V+ and ground pins.

Care should be taken to minimize the loop area formed by the bypass capacitor connection between V+ and ground.

The ground pin should be connected to the PCB ground plane at the pin of the device.

The feedback components should be placed as close to the device as possible to minimize strays.

11.2 Layout Example

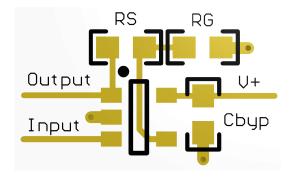


Figure 42. SOT-23 Layout Example (Top View)

12 Device and Documentation Support

12.1 Device Support

12.1.1 Development Support

TINA-TI SPICE-Based Analog Simulation Program, http://www.ti.com/tool/tina-ti

DIP Adapter Evaluation Module, http://www.ti.com/tool/dip-adapter-evm

TI Universal Operational Amplifier Evaluation Module, http://www.ti.com/tool/opampevm

TI FilterPro Filter Design Software, http://www.ti.com/tool/filterpro

12.2 Documentation Support

12.2.1 Related Documentation

For related documentation, see the following:

- AN-1798 Designing with Electro-Chemical Sensors, SNOA514
- AN-1803 Design Considerations for a Transimpedance Amplifier, SNOA515
- AN-1852 Designing With pH Electrodes, SNOA529
- Compensate Transimpedance Amplifiers Intuitively, SBOA055
- Transimpedance Considerations for High-Speed Operational Amplifiers, SBOA112
- Noise Analysis of FET Transimpedance Amplifiers, SBOA060
- Circuit Board Layout Techniques, SLOA089
- Handbook of Operational Amplifier Applications, SBOA092

12.3 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

TECHNICAL **TOOLS &** SUPPORT & PRODUCT FOLDER **SAMPLE & BUY PARTS DOCUMENTS SOFTWARE** COMMUNITY TLV8811 Click here Click here Click here Click here Click here TLV8812 Click here Click here Click here Click here Click here

Table 1. Related Links

12.4 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.5 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.6 Trademarks

E2E is a trademark of Texas Instruments.

12.7 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

12.8 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGE OPTION ADDENDUM

17-Oct-2016

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
TLV8811DBVR	PREVIEW	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125		
TLV8811DBVT	PREVIEW	SOT-23	DBV	5	250	TBD	Call TI	Call TI	-40 to 125		
TLV8812DGKR	PREVIEW	VSSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	TLV 8812	
TLV8812DGKT	PREVIEW	VSSOP	DGK	8	250	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	TLV 8812	



PACKAGE OPTION ADDENDUM

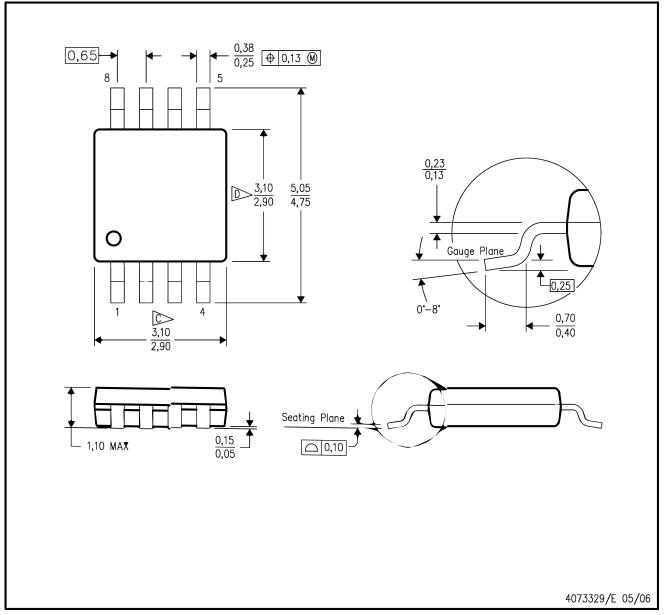
17-Oct-2016

continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE

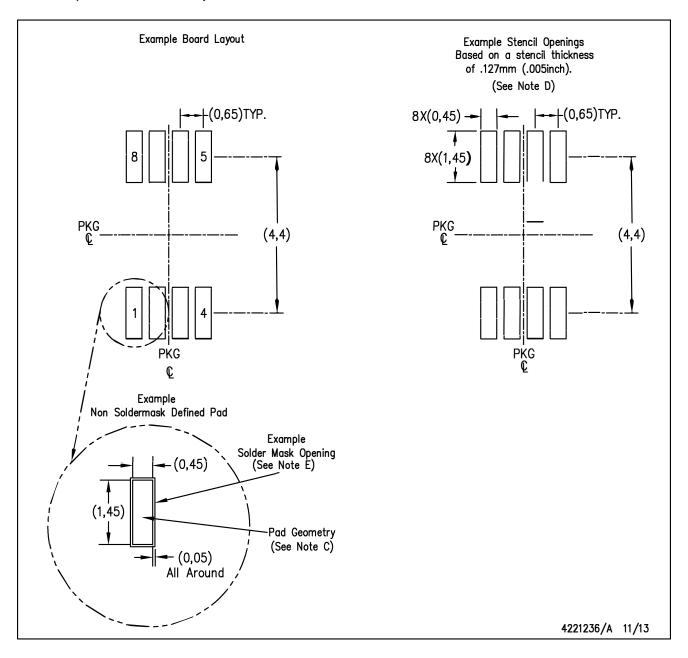


NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
- E. Falls within JEDEC MO-187 variation AA, except interlead flash.

DGK (S-PDSO-G8)

PLASTIC SMALL OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.